

PIC16(L)F1825/1829 Family Silicon Errata and Data Sheet Clarification

The PIC16(L)F1825/1829 family devices that you have received conform functionally to the current Device Data Sheet (DS40001440C), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).


The errata described in this document will be addressed in future revisions of the PIC16(L)F1825/1829 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A2**).

Data Sheet clarifications and corrections start on [page 9](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
 - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ().
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC16(L)F1825/1829 silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

| Part Number | DEVICE ID<13:0> ^{(1),(2)} | | |
|-------------|------------------------------------|----------------------------------|--------|
| | DEV<8:0> | Revision ID for Silicon Revision | |
| | | A0 | A2 |
| PIC16F1825 | 10 0111 011 | 0 0000 | 0 0010 |
| PIC16LF1825 | 10 1000 011 | 0 0000 | 0 0010 |
| PIC16F1829 | 10 0111 111 | 0 0000 | 0 0010 |
| PIC16LF1829 | 10 1000 111 | 0 0000 | 0 0010 |

- Note 1:** The Device ID is located in the configuration memory at address 8006h.
- 2:** Refer to the “PIC12(L)F1822/PIC16(L)F182X Memory Programming Specification” (DS41390) for detailed information on Device and Revision IDs for your specific device.

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TABLE 2: SILICON ISSUE SUMMARY

| Module | Feature | Item Number | Issue Summary | Affected Revisions ⁽¹⁾ | |
|---|-------------------------------------|-------------|--|-----------------------------------|----|
| | | | | A0 | A2 |
| Oscillator | LFINTOSC | 1.1 | Wake from Sleep. | X | |
| Oscillator | HFINTOSC Ready/ Stable bit | 1.2 | Bits remained set to '1' after initial trigger. | X | X |
| Oscillator | Clock Switching | 1.3 | Clock switching can cause a single corrupted instruction. | X | |
| Oscillator | Oscillator Start-up Timer | 1.4 | OSTS bit remains set. | X | X |
| Timer1 | T1 Gate Toggle mode | 2.1 | T1 Gate flip-flop does not clear. | X | |
| ADC | Error Parameters | 3.1 | Differential and gain error. | X | X |
| In-Circuit Serial Programming™ (ICSP™) | Low-Voltage Programming | 4.1 | Bulk Erase not available with LVP. | X | |
| Clock Switching | OSTS Status Bit | 5.1 | Remains clear when 4xPLL enabled. | X | X |
| MSSP (Master Synchronous Serial Port) | Slew Rate | 6.1 | Slow rate reduction on SSP2. | X | X |
| Enhanced Universal Synchronous Asynchronous Receiver (EUSART) | Auto-Baud Detect | 7.1 | Auto-Baud Detect may store incorrect count value in the SPBRG registers. | X | |
| Enhanced Universal Synchronous Asynchronous Receiver (EUSART) | 16-Bit High-Speed Asynchronous mode | 7.2 | Works improperly at maximum rate. | X | X |

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A2**).

1. Module: Oscillator

1.1 LFINTOSC

The device may not wake-up from Sleep mode when the LFINTOSC is selected as the system clock.

Work around

Enable the Fail-Safe Clock Monitor (FSCM) feature before initiating Sleep mode. When the Fail-Safe Clock Monitor (FSCM) feature is enabled before entering Sleep mode, the device will wake from Sleep.

Affected Silicon Revisions

| A0 | A2 | | | | | | | |
|----|----|--|--|--|--|--|--|--|
| X | | | | | | | | |

1.2 OSCSTAT bits: HFIOFR and HFIOFS

When HFINTOSC is selected, the HFIOFR and HFIOFS bits will become set when the oscillator becomes ready and stable. Once these bits are set, they become “stuck”, indicating that HFINTOSC is always ready and stable. If the HFINTOSC is disabled, the bits fail to be cleared.

Work around

None.

Affected Silicon Revisions

| A0 | A2 | | | | | | | |
|----|----|--|--|--|--|--|--|--|
| X | X | | | | | | | |

1.3 Clock Switching

When switching clock sources between INTOSC clock source and an external clock source, one corrupted instruction may be executed after the switch occurs.

This issue does not affect Two-Speed Start-up or the Fail-Safe Clock Monitor operation.

Work around

When switching from an external oscillator clock source, first switch to 16 MHz HFINTOSC. Once running at 16 MHz HFINTOSC, configure IRCF to run at desired internal oscillator frequency.

When switching from an internal oscillator (INTOSC) to an external oscillator clock source, first switch to HFINTOSC High-Power mode (8 MHz or 16 MHz). Once running from HFINTOSC, switch to the external oscillator clock source.

Affected Silicon Revisions

| A0 | A2 | | | | | | | |
|----|----|--|--|--|--|--|--|--|
| X | | | | | | | | |

1.4 Oscillator Start-up Timer

During the Two-Speed Start-up sequence, the Oscillator Start-up Timer is enabled to count 1024 clock cycles. After the count is reached, the OSTS bit is set, the system clock is held low until the next falling edge of the external crystal (LP, XT or HS mode), before switching to the external clock source.

When an external oscillator is configured as the primary clock and Fail-Safe Clock mode is enabled (FCMEN = 1), any of the following conditions will result in the Oscillator Start-up Timer failing to restart:

- MCLR Reset
- Wake from Sleep
- Clock change from INTOSC to Primary Clock

This anomaly will manifest itself as a clock failure condition for external oscillators which take longer than the clock failure time-out period to start.

Work around

None.

Affected Silicon Revisions

| A0 | A2 | | | | | | | |
|----|----|--|--|--|--|--|--|--|
| X | X | | | | | | | |

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2. Module: Timer1

2.1 Timer1 Gate Toggle mode

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal. To perform this function, the Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the gate signal. Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When working properly, clearing either the T1GTM bit or the TMR1ON bit would also clear the output value of this flip-flop, and hold it clear. This is done in order to control which edge is being measured. The issue that exists is that clearing the TMR1ON bit does not clear the output value of the flip-flop and hold it clear.

Work around

Clear the T1GTM bit in the T1GCON register to clear and hold clear the output value of the flip-flop.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | | | | | | | |

3. Module: ADC

3.1 ADC Differential and Gain Error Parameters

The differential and gain error parameters are as follows:

| Param No. | Sym. | Characteristic | Min. | Typ† | Max. | Units | Conditions |
|-----------|------------------|--------------------|------|------|------|-------|------------------------------------|
| AD03 | EDL | Differential Error | — | — | ±1.5 | LSb | VREF = 3.0V. Missing codes = 2 |
| AD04 | E _{OFF} | Offset Error | — | — | ±2 | LSb | VREF = 3.0V. At -40°C offset is ±3 |
| AD05 | E _{GN} | Gain Error | — | — | ±2 | LSb | VREF = 3.0V |

Work around

None.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | X | | | | | | |

4. Module: In-Circuit Serial Programming™ (ICSP™)

4.1 Bulk Erase Feature not available with Low-Voltage Programming mode

A bulk erase of the program Flash memory or data memory cannot be executed in Low-Voltage Programming mode.

Work around

Method 1: If ICSP Low-Voltage Programming mode is required, use row erases to erase the program memory, as described in the Program/Verify mode section of the Programming Specification. Data memory must be over-written with the desired values.

Method 2: Use ICSP High-Voltage Programming mode if a Bulk Erase is required.

Note: Only the Bulk Erase feature will erase program or data memory if code or data protection is enabled. Method 2 must be used if code or data protection is enabled.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | | | | | | | |

5. Module: Clock Switching

5.1 OSTS Status Bit

When the 4xPLL is enabled, the Oscillator Start-up Time-out Status (OSTS) bit always remains clear.

Work around

None.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | X | | | | | | |

6. Module: MSSP (Master Synchronous Serial Port)

6.1 Unintentional SPI Slew Rate Reduction on SSP2

This issue is caused when SSP2 is configured for SPI Master mode while SSP1 is set up for I²C™ Slave/Master mode with the slew rate (SMP) bit set. This limits SPI bit rates and can cause triangle wave output which is proportional to the speed of the clock. It is most noticeable when the SPI clock exceeds 500 kHz. The selected mode in SSP2 does not affect this issue (CKP/CKE bits).

Work around

1. Disable slew rate control on SSP1 by clearing the SMP bit;
2. Select the alternate pin for SSP2 output;
3. Swap the functionality of the modules;
4. Configure SSP2 with a slower SPI clock.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | X | | | | | | |

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7. Module: Enhanced Universal Synchronous Asynchronous Receiver (EUSART)

7.1 Auto-Baud Detect

When using automatic baud detection (ABDEN), on occasion, an incorrect count value can be stored at the end of auto-baud detection in the SPBRGH:SPBRGL (SPBRG) registers. The SPBRG value may be off by several counts. This condition happens sporadically when the device clock frequency drifts to a frequency where the SPBRG value oscillates between two different values. The issue is present regardless of the baud rate Configuration bit settings.

Work around

When using auto-baud, it is a good practice to always verify the obtained value of SPBRG, to ensure it remains within the application specifications. Two recommended methods are shown below.

For additional auto-baud information, see Technical Brief TB3069, "Use of Auto-Baud for Reception of LIN Serial Communications Devices: Mid-Range and Enhanced Mid-Range".

EXAMPLE 1: METHOD 1 – EUSART AUTO-BAUD DETECT WORK AROUND

In firmware, define default, minimum and maximum auto-baud (SPBRG) values according to the application requirements.

For example, if the application runs at 9600 baud at 16 MHz then, the default SPBRG value would be (assuming 16-bit/Asynchronous mode) 0x67. The minimum and maximum allowed values can be calculated based on the application. In this example, a +/-5% tolerance is required, so tolerance is $0x67 * 5\% = 0x05$.

```
#define SPBRG_16BIT    *((*int)&SPBRG;           // define location for 16-bit SPBRG value

const int DEFAULT_BAUD = 0x0067;              // Default Auto-Baud value
const int TOL = 0x05;                          // Baud Rate % tolerance
const int MIN_BAUD = DEFAULT_BAUD - TOL;       // Minimum Auto-Baud Limit
const int MAX_BAUD = DEFAULT_BAUD + TOL;       // Maximum Auto-Baud Limit
.
.
.

ABDEN = 1;                                     // Start Auto-Baud
while (ABDEN);                                 // Wait until Auto-Baud completes

if((SPBRG_16BIT > MAX_BAUD) || (SPBRG_16BIT < MIN_BAUD))
{
    SPBRG_16BIT = DEFAULT_BAUD;                // Compare if value is within limits
                                              // if out of spec, use DEFAULT_BAUD
}
.
.
.
// if in spec, continue using the
// Auto-Baud value in SPBRG
```

EXAMPLE 2: METHOD 2 – EUSART AUTO-BAUD DETECT WORK AROUND

Similar to Method 1, define default, minimum and maximum auto-baud (SPBRG) values. In firmware, compute a running average of SPBRG. If the new SPBRG value falls outside the minimum or maximum limits, then use the current running average value (Average_Baud), otherwise use the auto-baud SPBRG value and calculate a new running average.

For example, if the application runs at 9600 baud at 16 MHz then, the default SPBRG value would be (assuming 16-bit/ Asynchronous mode) 0x67. The minimum and maximum allowed values can be calculated based on the application. In this example, a +/-5% tolerance is required, so tolerance is $0x67 * 5\% = 0x05$.

```
#define SPBRG_16BIT    *((*int)&SPBRG;                // define location for 16-bit SPBRG value

const int DEFAULT_BAUD = 0x0067;                    // Default Auto-Baud value
const int TOL = 0x05;                               // Baud Rate % tolerance
const int MIN_BAUD = DEFAULT_BAUD - TOL;           // Minimum Auto-Baud Limit
const int MAX_BAUD = DEFAULT_BAUD + TOL;           // Maximum Auto-Baud Limit

int Average_Baud;                                    // Define Average_Baud variable
int Integrator;                                     // Define Integrator variable
.
.
.

Average_Baud = DEFAULT_BAUD;                        // Set initial average Baud rate
Integrator = DEFAULT_BAUD*15;                       // The running 16 count average
.
.
.

ABDEN = 1;                                          // Start Auto-Baud
while (ABDEN);                                     // Wait until Auto-Baud completes

Integrator+ = SPBRG_16BIT;
Average_Baud = Integrator/16;
if((SPBRG_16BIT > MAX_BAUD)|| (SPBRG_16BIT < MIN_BAUD))
{
    SPBRG_16BIT = Average_Baud;                    // Check if value is within limits
                                                    // If out of spec, use previous average
}
else
{                                                    // If in spec, calculate the running
                                                    // average but continue using the
    Integrator+ = SPBRG_16BIT;                    // Auto-Baud value in SPBRG
    Average_Baud = Integrator/16;
    Integrator- = Average_Baud;
}
.
.
.
```

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | | | | | | | |

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7.2 16-Bit High-Speed Asynchronous Mode

EUSART provides unexpected operation when the 16-bit High-Speed Asynchronous mode is selected and the Baud Rate Generator Data register values are loaded with zero ('0'). The use of this configuration is not recommended for EUSART communication. The configuration is shown below in the following table:

| Configuration Bits | | | BRG Data Registers | |
|--------------------|-------|------|--------------------|--------------|
| SYNC | BRG16 | BRGH | SPBRGH Value | SPBRGL Value |
| 0 | 1 | 1 | 00000000 | 00000000 |

Work around

Ensure that the SPBRGH or the SPBRGL register is loaded with a non-zero value.

Affected Silicon Revisions

| A0 | A2 | | | | | | |
|----|----|--|--|--|--|--|--|
| X | X | | | | | | |

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001440C):

| |
|---|
| <p>Note: Corrections are shown in bold. Where possible, the original bold text formatting has been removed for clarity.</p> |
|---|

None.

PIC16(L)F1825/1829

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (01/2011)

Initial release of this document.

Rev B Document (11/2011)

Added Module 6, MSSP.

Rev C Document (02/2012)

Updated Table 1; Added Modules 1.3, 1.4, 1.5; Added Module 7, EUSART; Other minor corrections.

Data Sheet Clarifications: Added Module 1, Oscillator.

Rev D Document (11/2012)

Removed Module 1.1, HS Oscillator; Added Silicon Revision A2.

Rev E Document (10/2013)

Added Module 7.2, 16-Bit High-Speed Asynchronous Mode; Other minor corrections.

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